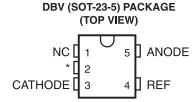


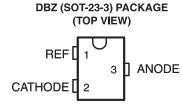
LOW-VOLTAGE ADJUSTABLE PRECISION SHUNT REGULATORS

Check for Samples: TLVH431A-Q1, TLVH431B-Q1

FEATURES

- Qualified for Automotive Applications
- Low-Voltage Operation: Down to 1.24 V
- Reference Voltage Tolerances at 25°C
 - 0.5% for B Grade
 - 1% for A Grade
- Adjustable Output Voltage, V_O = V_{REF} to 18 V
- Wide Operating Cathode Current Range: 100 µA to 70 mA
- 0.25-Ω Typical Output Impedance
- –40°C to 125°C Specifications





NC - No internal connection

DESCRIPTION/ORDERING INFORMATION

The TLVH431 devices are low-voltage 3-terminal adjustable voltage references, with thermal stability specified over the automotive temperature range. Output voltage can be set to any value between V_{REF} (1.24 V) and 18 V with two external resistors (see Figure 2). These devices operate from a lower voltage (1.24 V) than the widely used TL431 and TL1431 shunt-regulator references.

When used with an optocoupler, the TLVH431 devices are ideal voltage reference in isolated feedback circuits for 3-V to 3.3-V switching-mode power supplies. They have a typical output impedance of 0.25 Ω . Active output circuitry provides a very sharp turn-on characteristic, making the TLVH431 an excellent replacement for low-voltage Zener diodes in many applications, including on-board regulation and adjustable power supplies.

ORDERING INFORMATION(1)

T _A	V _{REF} TOLERANCE	PACKAG	iE ⁽²⁾	ORDERABLE PART NUMBER	TOP-SIDE MARKING
	0.5%	SOT-23-5 – DBV	Reel of 3000	TLVH431BQDBVRQ1	VOPQ
–40°C to 125°C	0.5%	SOT-23-3 - DBZ	Reel of 3000	TLVH431BQDBZRQ1	VPIQ
	1%	SOT-23-5 – DBV	Reel of 3000	TLVH431AQDBVRQ1	VOOQ

⁽¹⁾ For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI web site at www.ti.com.

(2) Package drawings, thermal data, and symbolization are available at www.ti.com/packaging.

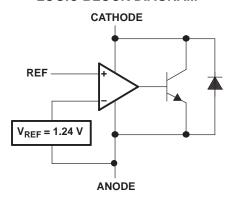


Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

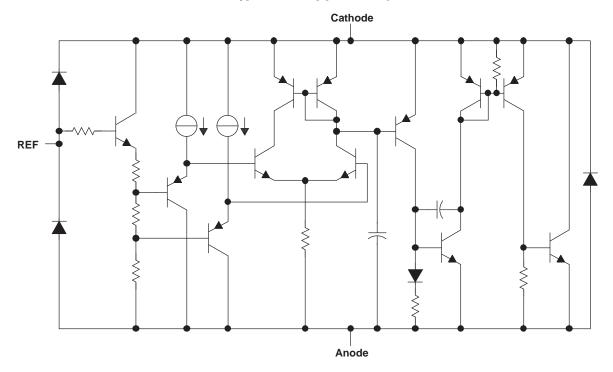
^{*} Pin 2 is attached to Substrate and must be connected to ANODE or left open.



LOGIC BLOCK DIAGRAM



EQUIVALENT SCHEMATIC





ABSOLUTE MAXIMUM RATINGS(1)

over operating free-air temperature range (unless otherwise noted)

V_{KA}	Cathode voltage ⁽²⁾	20 V
I_{K}	Cathode current range	–25 mA to 80 mA
I _{ref}	Reference current range	-0.05 mA to 3 mA
θ_{JA}	Package thermal impedance (3) (4)	206°C/W
TJ	Operating virtual junction temperature	150°C
T _{stg}	Storage temperature range	−65°C to 150°C

- (1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) Voltage values are with respect to the anode terminal, unless otherwise noted.
- (3) Maximum power dissipation is a function of $T_J(max)$, θ_{JA} , and T_A . The maximum allowable power dissipation at any allowable ambient temperature is $P_D = (T_J(max) T_A)/\theta_{JA}$. Operating at the absolute maximum T_J of 150°C can affect reliability.
- (4) The package thermal impedance is calculated in accordance with JESD 51-7.

RECOMMENDED OPERATING CONDITIONS

		MIN	MAX	UNIT
V_{KA}	Cathode voltage	V_{REF}	18	٧
I _K	Cathode current (continuous)	0.1	70	mA
T _A	Operating free-air temperature	-40	125	°C



TLVH431A ELECTRICAL CHARACTERISTICS

at 25°C free-air temperature (unless otherwise noted)

	PARAMETER	TEST CO	MIN	TYP	MAX	UNIT	
			T _A = 25°C	1.228	1.24	1.252	
V_{REF}	Reference voltage	$V_{KA} = V_{REF}$, $I_K = 10 \text{ mA}$	T _A = full range ⁽¹⁾ (see Figure 1)	1.209		1.271	V
V _{REF(dev)}	V_{REF} deviation over full temperature range $^{(1)}$ $^{(2)}$	V _{KA} = V _{REF} , I _K = 10 mA (see Figure 1)			11	31	mV
$\frac{\Delta V_{REF}}{\Delta V_{KA}}$	Ratio of V _{REF} change to cathode voltage change	$V_{K} = V_{REF}$ to 18 V, $I_{K} = 10$		-1.5	-2.7	mV/V	
I _{ref}	Reference terminal current	I_K = 10 mA, R1 = 10 kΩ, I	$I_K = 10 \text{ mA}$, R1 = 10 k Ω , R2 = open (see Figure 2)				μA
I _{ref(dev)}	I _{ref} deviation over full temperature range ⁽¹⁾ (2)	$I_{K} = 10 \text{ mA}, R1 = 10 \text{ k}\Omega, I$	$I_K = 10 \text{ mA}, R1 = 10 \text{ k}\Omega, R2 = \text{open (see Figure 2)}$			0.5	μΑ
I _{K(min)}	Minimum cathode current for regulation	$V_{KA} = V_{REF}$ (see Figure 1)		60	100	μΑ	
I _{K(off)}	Off-state cathode current	V _{REF} = 0, V _{KA} = 18 V (see		0.02	0.1	μA	
z _{KA}	Dynamic impedance ⁽³⁾	$V_{KA} = V_{REF}, f \le 1 \text{ kHz}, I_K :$ (see Figure 1)		0.25	0.4	Ω	

Full temperature range is -40°C to 125°C.

The deviation parameters $V_{REF(dev)}$ and $I_{ref(dev)}$ are defined as the differences between the maximum and minimum values obtained over the rated temperature range. The average full-range temperature coefficient of the reference input voltage, αV_{REF} , is defined as: $\frac{\left(\frac{V_{REF(dev)}}{V_{REF}(T_A=25^{\circ}C)}\right) \times 10^{6}}{\left(\frac{V_{REF}}{V_{REF}}\right)} = \frac{\left(\frac{V_{REF(dev)}}{V_{REF}}\right) \times 10^{6}}{\left(\frac{V_{REF}}{V_{REF}}\right)} = \frac{\left(\frac{V_{REF(dev)}}{V_{REF}}\right) \times 10^{6}}{\left(\frac{V_{REF}}{V_{REF}}\right)} = \frac{\left(\frac{V_{REF(dev)}}{V_{REF}}\right) \times 10^{6}}{\left(\frac{V_{REF}}{V_{REF}}\right)} = \frac{\left(\frac{V_{REF}}{V_{REF}}\right) \times 10^{6}}{\left(\frac{V_{REF}}{V_{REF}}\right)} = \frac{\left(\frac{V_{REF}}{V_{REF}}\right) \times 10^{6}}{\left(\frac{V_{REF}}{V_{REF}}\right)} = \frac{\left(\frac{V_{REF}}{V_{REF}}\right) \times 10^{6}}{\left(\frac{V_{REF}}{V_{REF}}\right)} = \frac{\left(\frac{V_{REF}}{V_{REF}}\right) \times 10^{6}}{\left(\frac{V_{REF}}{V_{REF}}\right)} = \frac{10^{6}}{V_{REF}}$

$$|\alpha V_{REF}| \left(\frac{ppm}{{}^{\circ}C}\right) = \frac{\left(\frac{V_{REF(dev)}}{V_{REF}(T_A = 25{}^{\circ}C)}\right) \times 10^6}{\Delta T_A}$$

where ΔT_A is the rated operating free-air temperature range of the device. αV_{REF} can be positive or negative, depending on whether minimum V_{REF} or maximum V_{REF} , respectively, occurs at the lower

(3) The dynamic impedance is defined as: $|z_{KA}| = \frac{\Delta^{V} KA}{\Delta^{I} K}$

$$|z_{KA}| = \frac{\Delta V_{KA}}{\Delta I_{K}}$$

When the device is operating with two external resistors (see Figure 2), the total dynamic impedance of the circuit is defined as: $\left|z_{KA}\right| = \frac{\Delta V}{\Delta I} \approx \left|z_{KA}\right| \times \left(1 + \frac{R1}{R2}\right)$

$$|z_{KA}| = \frac{\Delta V}{\Delta I} \approx |z_{KA}| \times \left(1 + \frac{R1}{R2}\right)$$



TLVH431B ELECTRICAL CHARACTERISTICS

at 25°C free-air temperature (unless otherwise noted)

	PARAMETER	TEST CO	NDITIONS	MIN	TYP	MAX	UNIT
			$T_A = 25^{\circ}C$	1.234	1.24	1.246	
V_{REF}	Reference voltage	$V_{KA} = V_{REF}$, $I_K = 10 \text{ mA}$	T _A = full range ⁽¹⁾ (see Figure 1)	1.221		1.265	V
V _{REF(dev)}	V_{REF} deviation over full temperature range $^{(1)}$ $^{(2)}$	$V_{KA} = V_{REF}$, $I_K = 10$ mA (s		11	31	mV	
$\frac{\Delta V_{REF}}{\Delta V_{KA}}$	Ratio of $V_{\mbox{\scriptsize REF}}$ change to cathode voltage change	$I_K = 10 \text{ mA}, V_K = V_{REF} \text{ to}$		-1.5	-2.7	mV/V	
I _{ref}	Reference terminal current	$I_K = 10 \text{ mA}, R1 = 10 \text{ k}\Omega, F$		0.1	0.5	μΑ	
I _{ref(dev)}	I _{ref} deviation over full temperature range ⁽¹⁾ (2)	I_K = 10 mA, R1 = 10 kΩ, F	$I_K = 10 \text{ mA}, R1 = 10 \text{ k}\Omega, R2 = \text{open (see Figure 2)}$		0.15	0.5	μΑ
I _{K(min)}	Minimum cathode current for regulation	V _{KA} = V _{REF} (see Figure 1)			60	100	μΑ
I _{K(off)}	Off-state cathode current	$V_{REF} = 0$, $V_{KA} = 18 \text{ V}$ (see		0.02	0.1	μΑ	
z _{KA}	Dynamic impedance (3)	$V_{KA} = V_{REF}, f \le 1 \text{ kHz}, I_K :$ (see Figure 1)	= 0.1 mA to 70 mA		0.25	0.4	Ω

- Full temperature range is -40°C to 125°C.
- The deviation parameters $V_{REF(dev)}$ and $I_{ref(dev)}$ are defined as the differences between the maximum and minimum values obtained over the rated temperature range. The average full-range temperature coefficient of the reference input voltage, αV_{REF} , is defined as: $\frac{\left(\frac{V_{REF(dev)}}{V_{REF}(T_A=25^{\circ}C)}\right) \times 10^{6}}{\left(\frac{V_{REF}(T_A=25^{\circ}C)}{V_{REF}(T_A=25^{\circ}C)}\right)} \times 10^{6}$

$$|\alpha V_{REF}| \left(\frac{ppm}{oC}\right) = \frac{\left(\frac{V_{REF(dev)}}{V_{REF}(T_A = 25^{\circ}C)}\right) \times 10^6}{\Delta T_A}$$

where ΔT_A is the rated operating free-air temperature range of the device. αV_{REF} can be positive or negative, depending on whether minimum V_{REF} or maximum V_{REF} , respectively, occurs at the lower

The dynamic impedance is defined as: $\left|z_{KA}\right| = \frac{\Delta^V KA}{\Delta^I K}$

$$|z_{KA}| = \frac{\Delta V_{KA}}{\Delta I_{K}}$$

When the device is operating with two external resistors (see Figure 2), the total dynamic impedance of the circuit is defined as: $\left|z_{KA}\right| = \frac{\Delta V}{\Delta I} \approx \left|z_{KA}\right| \times \left(1 + \frac{R1}{R2}\right)$

$$|z_{KA}| = \frac{\Delta V}{\Delta I} \approx |z_{KA}| \times \left(1 + \frac{R1}{R2}\right)$$

Product Folder Link(s): TLVH431A-Q1 TLVH431B-Q1



PARAMETER MEASUREMENT INFORMATION

Operation of the device at any conditions beyond those indicated under *recommended operating conditions* is not implied.

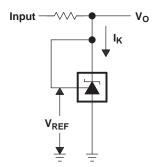


Figure 1. Test Circuit for $V_{KA} = V_{REF}$, $V_{O} = V_{KA} = V_{REF}$

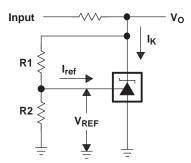


Figure 2. Test Circuit for $V_{KA} > V_{REF}$, $V_{O} = V_{KA} = V_{REF} \times (1 + R1/R2) + I_{ref} \times R1$

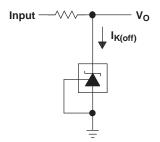


Figure 3. Test Circuit for I_{K(off)}



REFERENCE VOLTAGE vs JUNCTION TEMPERATURE

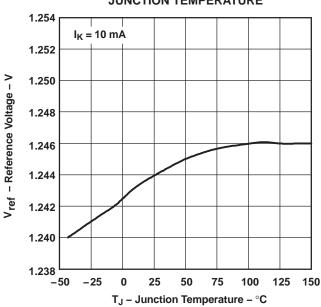
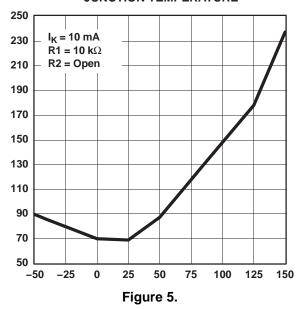


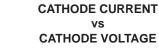
Figure 4.

REFERENCE INPUT CURRENT

JUNCTION TEMPERATURE







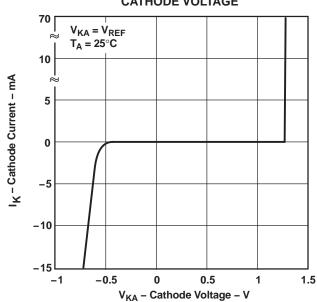


Figure 6.

CATHODE CURRENT vs CATHODE VOLTAGE

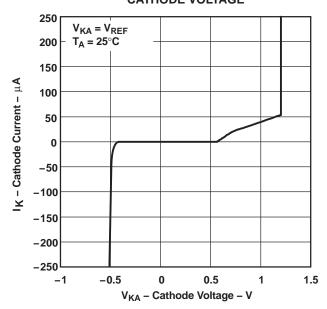


Figure 7.



OFF-STATE CATHODE CURRENT vs JUNCTION TEMPERATURE

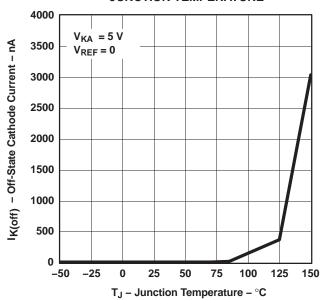


Figure 8.

RATIO OF DELTA REFERENCE VOLTAGE TO DELTA CATHODE VOLTAGE

JUNCTION TEMPERATURE

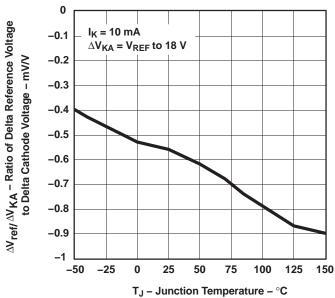
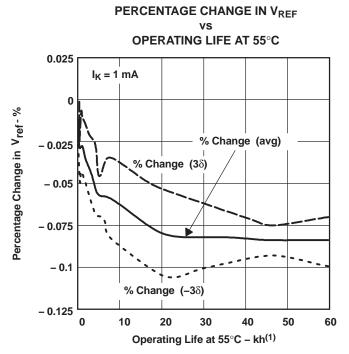


Figure 9.

TEXAS INSTRUMENTS

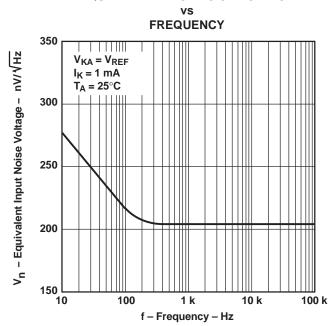
PARAMETER MEASUREMENT INFORMATION (continued)

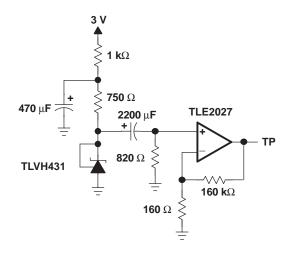


(1) Extrapolated from life-test data taken at 125°C; the activation energy assumed is 0.7 eV.

Figure 10.

EQUIVALENT INPUT NOISE VOLTAGE



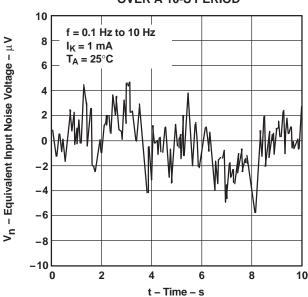


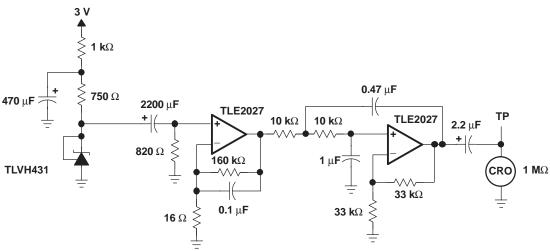
TEST CIRCUIT FOR EQUIVALENT INPUT NOISE VOLTAGE

Figure 11.



EQUIVALENT INPUT NOISE VOLTAGE OVER A 10-S PERIOD





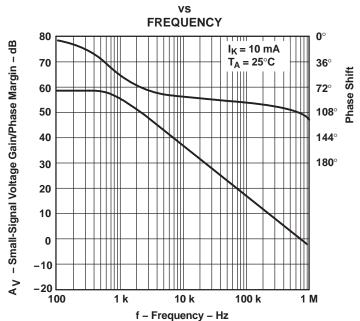
TEST CIRCUIT FOR 0.1-Hz TO 10-Hz EQUIVALENT NOISE VOLTAGE

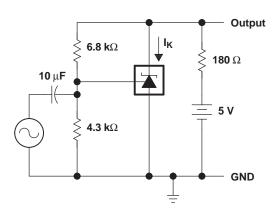
Figure 12.

TEXAS INSTRUMENTS

PARAMETER MEASUREMENT INFORMATION (continued)

SMALL-SIGNAL VOLTAGE GAIN /PHASE MARGIN



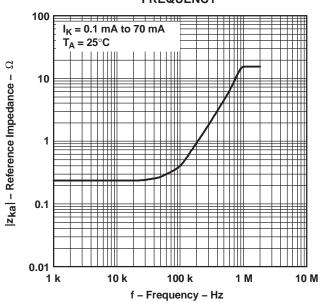


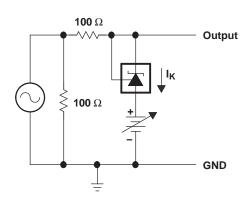
TEST CIRCUIT FOR VOLTAGE GAIN AND PHASE MARGIN

Figure 13.

REFERENCE IMPEDANCE

vs FREQUENCY

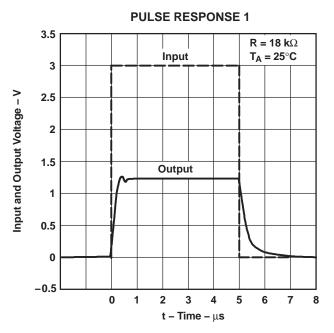


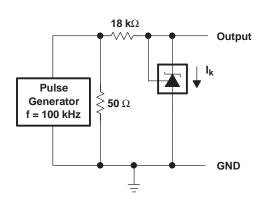


TEST CIRCUIT FOR REFERENCE IMPEDANCE

Figure 14.

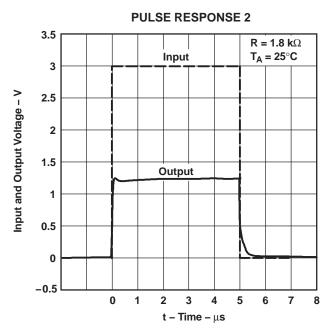


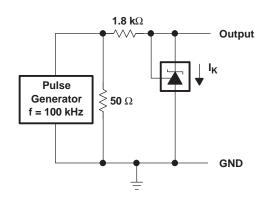




TEST CIRCUIT FOR PULSE RESPONSE 1

Figure 15.





TEST CIRCUIT FOR PULSE RESPONSE 2

Figure 16.



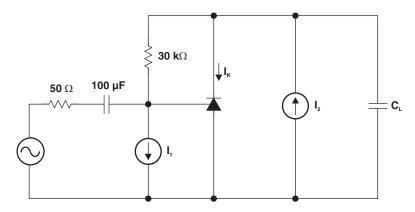


Figure 17. Phase Margin Test Circuit

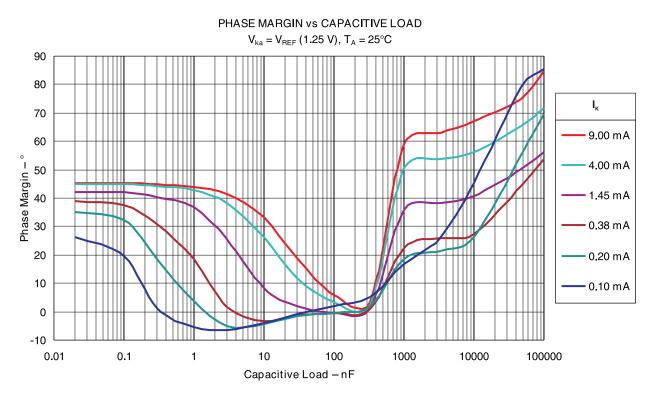


Figure 18.



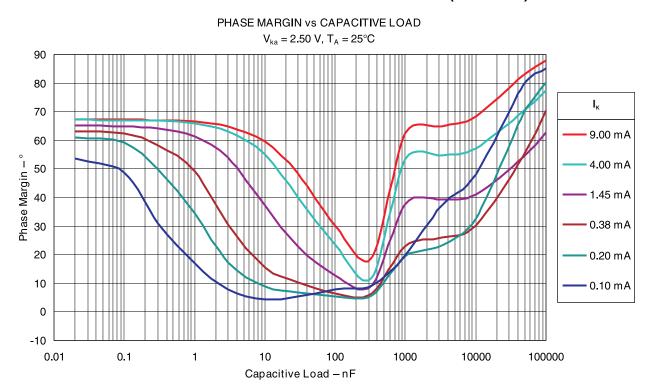


Figure 19.

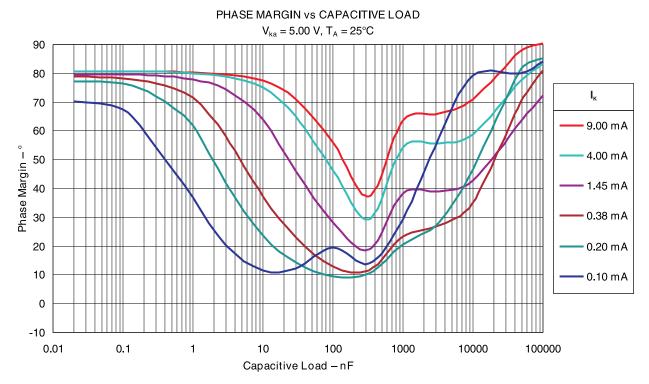


Figure 20.



APPLICATION INFORMATION

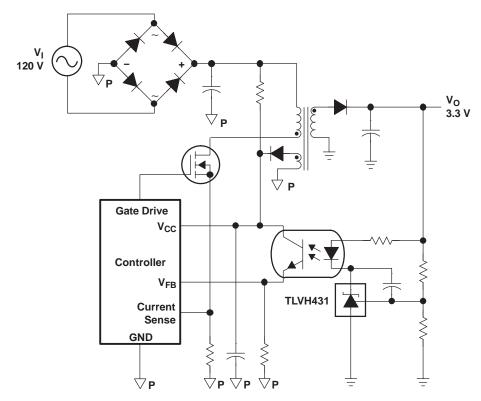


Figure 21. Flyback With Isolation Using TLVH431 as Voltage Reference and Error Amplifier

Figure 21 shows the TLVH431 used in a 3.3-V isolated flyback supply. Output voltage V_O can be as low as reference voltage V_{REF} (1.24 V). The output of the regulator plus the forward voltage drop of the optocoupler LED (1.24 + 1.4 = 2.64 V) determine the minimum voltage that can be regulated in an isolated supply configuration. Regulated voltage as low as 2.7 Vdc is possible in the topology shown in Figure 21.

7-Oct-2025

www.ti.com

PACKAGING INFORMATION

Orderable part number	Status	Material type	Package Pins	Package qty Carrier	RoHS	Lead finish/ Ball material	MSL rating/ Peak reflow	Op temp (°C)	Part marking
	(1)	(2)			(3)	(4)	(5)		(6)
TLVH431AQDBVRQ1	Active	Production	SOT-23 (DBV) 5	3000 LARGE T&R	Yes	NIPDAU SN	Level-1-260C-UNLIM	-40 to 125	VOOQ
TLVH431AQDBVRQ1.A	Active	Production	SOT-23 (DBV) 5	3000 LARGE T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 125	VOOQ
TLVH431BQDBVRQ1	Active	Production	SOT-23 (DBV) 5	3000 LARGE T&R	Yes	NIPDAU SN	Level-1-260C-UNLIM	-40 to 125	VOPQ
TLVH431BQDBVRQ1.A	Active	Production	SOT-23 (DBV) 5	3000 LARGE T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 125	VOPQ
TLVH431BQDBZRQ1	Active	Production	SOT-23 (DBZ) 3	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	VPIQ
TLVH431BQDBZRQ1.A	Active	Production	SOT-23 (DBZ) 3	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	VPIQ
TLVH431BQDBZRQ1G4	Active	Production	SOT-23 (DBZ) 3	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	VPIQ
TLVH431BQDBZRQ1G4.A	Active	Production	SOT-23 (DBZ) 3	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	VPIQ

⁽¹⁾ Status: For more details on status, see our product life cycle.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

⁽²⁾ Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

⁽⁴⁾ Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

⁽⁵⁾ MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

⁽⁶⁾ Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

PACKAGE OPTION ADDENDUM

www.ti.com 7-Oct-2025

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

OTHER QUALIFIED VERSIONS OF TLVH431A-Q1, TLVH431B-Q1:

● Catalog : TLVH431A, TLVH431B

● Enhanced Product : TLVH431B-EP

NOTE: Qualified Version Definitions:

- Catalog TI's standard catalog product
- Enhanced Product Supports Defense, Aerospace and Medical Applications



www.ti.com 29-Oct-2025

TAPE AND REEL INFORMATION





A0	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TLVH431AQDBVRQ1	SOT-23	DBV	5	3000	180.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
TLVH431AQDBVRQ1	SOT-23	DBV	5	3000	179.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
TLVH431BQDBVRQ1	SOT-23	DBV	5	3000	179.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
TLVH431BQDBVRQ1	SOT-23	DBV	5	3000	180.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
TLVH431BQDBVRQ1	SOT-23	DBV	5	3000	180.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
TLVH431BQDBZRQ1	SOT-23	DBZ	3	3000	179.0	8.4	3.15	2.95	1.22	4.0	8.0	Q3
TLVH431BQDBZRQ1G4	SOT-23	DBZ	3	3000	179.0	8.4	3.15	2.95	1.22	4.0	8.0	Q3



www.ti.com 29-Oct-2025



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TLVH431AQDBVRQ1	SOT-23	DBV	5	3000	210.0	185.0	35.0
TLVH431AQDBVRQ1	SOT-23	DBV	5	3000	200.0	183.0	25.0
TLVH431BQDBVRQ1	SOT-23	DBV	5	3000	200.0	183.0	25.0
TLVH431BQDBVRQ1	SOT-23	DBV	5	3000	210.0	185.0	35.0
TLVH431BQDBVRQ1	SOT-23	DBV	5	3000	210.0	185.0	35.0
TLVH431BQDBZRQ1	SOT-23	DBZ	3	3000	200.0	183.0	25.0
TLVH431BQDBZRQ1G4	SOT-23	DBZ	3	3000	200.0	183.0	25.0





NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
 2. This drawing is subject to change without notice.
 3. Reference JEDEC MO-178.

- 4. Body dimensions do not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.25 mm per side.
- 5. Support pin may differ or may not be present.





NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.





NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.







NOTES:

- All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
 This drawing is subject to change without notice.
 Reference JEDEC registration TO-236, except minimum foot length.

- 4. Support pin may differ or may not be present.
- 5. Body dimensions do not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.25mm per side





NOTES: (continued)

- 5. Publication IPC-7351 may have alternate designs.6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.





NOTES: (continued)

- 7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 8. Board assembly site may have different recommendations for stencil design.



IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATASHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, regulatory or other requirements.

These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you fully indemnify TI and its representatives against any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to TI's Terms of Sale, TI's General Quality Guidelines, or other applicable terms available either on ti.com or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products. Unless TI explicitly designates a product as custom or customer-specified, TI products are standard, catalog, general purpose devices.

TI objects to and rejects any additional or different terms you may propose.

Copyright © 2025, Texas Instruments Incorporated

Last updated 10/2025